



DMT67M8LPSW

PowerDI5060-8

Product Summary

BV _{DSS}	Rds(on) max	I _{D MAX} T _C = +25°С
60V	6.2mΩ @ V _{GS} = 10V	82A
000	8.5mΩ @ Vgs = 4.5V	70A

Description and Applications

This MOSFET is designed to minimize the on-state resistance $(R_{DS(ON)})$ yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

• Synchronous rectifiers

- DC-DC converters
- Power management

Features

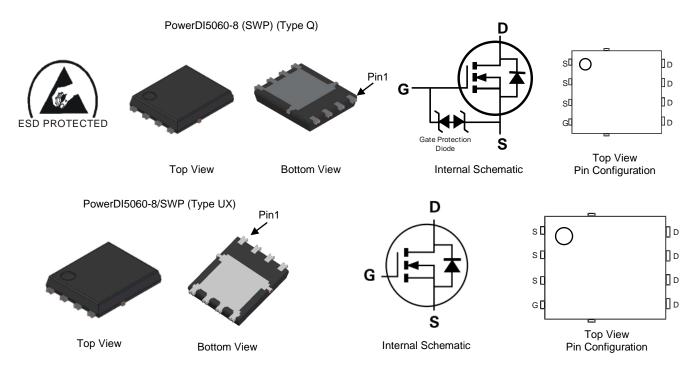
 100% Unclamped Inductive Switching (UIS) Test in Production — Ensures More Reliable and Robust End Application

60V N-CHANNEL ENHANCEMENT MODE MOSFET

- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On State Losses
- Low Input Capacitance
- Fast Switching Speed
- ESD Protected Gate
- Wettable Flank for Improved Optical Inspection
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

Mechanical Data

- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)



Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and
- Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

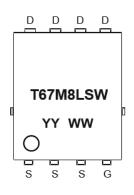


Ordering Information (Note 4)

Orderable Part Number	Paakaga	Packing		
	Package	Qty.	Carrier	
DMT67M8LPSW-13	PowerDI5060-8 (SWP) (Type Q)	2500	Tape & Reel	
DMT67M8LPSW-13	PowerDI5060-8/SWP (Type UX)	2500	Tape & Reel	

Note: 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



D | | = Manufacturer's Marking T67M8LSW = Product Type Marking Code YYWW or YYWW = Date Code Marking YY or YY = Last Two Digits of Year (ex: 24 = 2024) WW = Week Code (01 to 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	Vdss	60	V	
Gate-Source Voltage		Vgss	±20	V
Continuous Drain Current (Note 5) // 10)/	T _A = +25°C	I.	17.3	А
Continuous Drain Current (Note 5) $V_{GS} = 10V$	T _A = +70°C	I _D	13.8	
	Tc = +25°C		82	А
Continuous Drain Current (Note 6) V _{GS} = 10V	Tc = +70°C	١D	65.6	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	•	Ідм	320	А
Maximum Continuous Body Diode Forward Current (Note 6)		ls	82	А
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)	Ism	320	А	
Avalanche Current, L = 0.3mH		las	23.7	А
Avalanche Energy, L = 0.3mH		Eas	84.5	mJ

Notes: 5. Device mounted on FR-4 substrate PCB, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

6. Thermal resistance from junction to soldering point (on the exposed drain pad).



Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	2.8	W
Thermal Resistance, Junction to Ambient (Note 5)		Reja	45	°C/W
Total Power Dissipation (Note 6)	Tc = +25°C	PD	62.5	W
Thermal Resistance, Junction to Case (Note 6)		Rejc	2	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	60	—	—	V	$V_{GS} = 0V, I_D = 1mA$
Zero Gate Voltage Drain Current	IDSS	—	_	1	μA	$V_{DS} = 48V, V_{GS} = 0V$
Gate-Source Leakage	IGSS	_	_	±10	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	1.2	1.64	2.5	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
Static Drain-Source On-Resistance	Deserve	—	4.4	6.2	mΩ	VGS = 10V, ID = 20A
Static Drain-Source On-Resistance	RDS(ON)	_	6.2	8.5	11122	V _{GS} = 4.5V, I _D = 20A
Diode Forward Voltage	Vsd	—	0.7	1.2	V	$V_{GS} = 0V$, $I_{S} = 1A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	—	2130	—	pF	$V_{DS} = 30V, V_{GS} = 0V,$ f = 1MHz
Output Capacitance	Coss	—	786	—		
Reverse Transfer Capacitance	Crss	—	70	_		
Gate Resistance	Rg	_	0.6	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge (V _{GS} = 4.5V)	Qg	—	20	_		
Total Gate Charge (V _{GS} = 10V)	Qg	_	37.5	_	nC	V _{DS} = 30V, I _D = 20A
Gate-Source Charge	Qgs	_	5.4	_	nc	
Gate-Drain Charge	Q _{gd}	_	9.5	_		
Turn-On Delay Time	tD(ON)	—	5.5	_		
Turn-On Rise Time	tR	_	6.8	_	ns	$\label{eq:VDD} \begin{array}{l} V_{DD}=30V, \ V_{GS}=10V, \\ I_D=20A, \ R_g=3\Omega \end{array}$
Turn-Off Delay Time	t _{D(OFF)}	—	22.1	_		
Turn-Off Fall Time	tF	_	10.8			
Reverse Recovery Time	trr	_	26.9		ns	
Reverse Recovery Charge	QRR	—	56.8	—	nC IF = 20A, di/dt = 300A/µs	

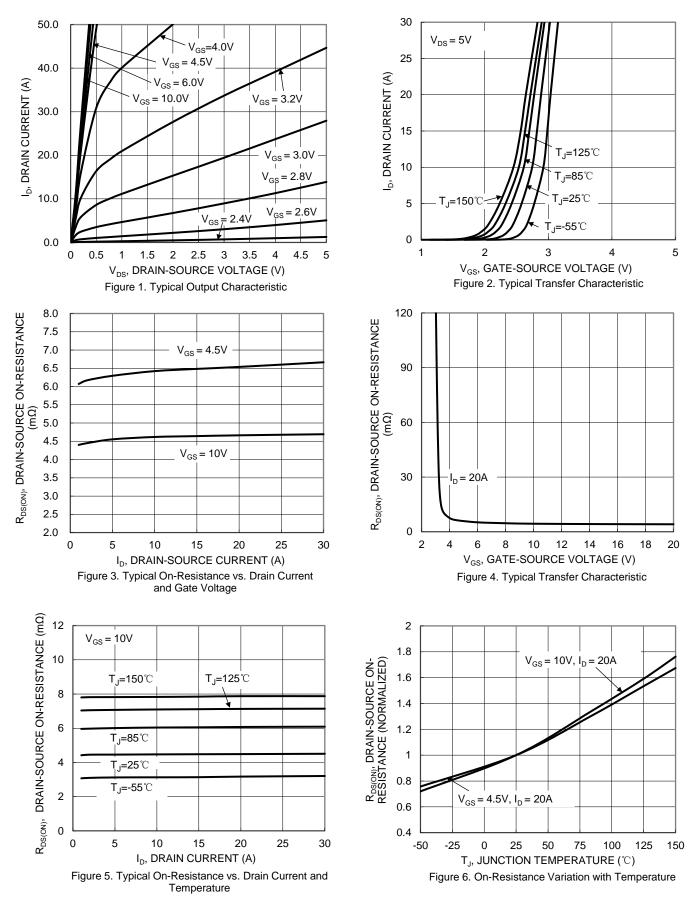
5. Device mounted on FR-4 substrate PCB, 2oz copper, with thermal bias to bottom layer 1inch square copper plate. Notes:

6. Thermal resistance from junction to soldering point (on the exposed drain pad).

Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to product testing.

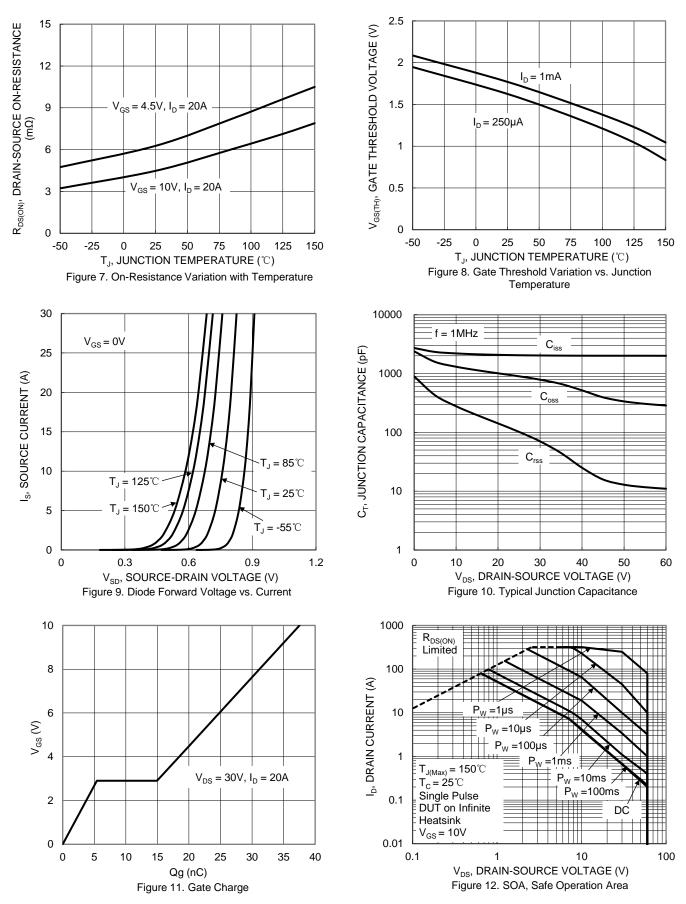


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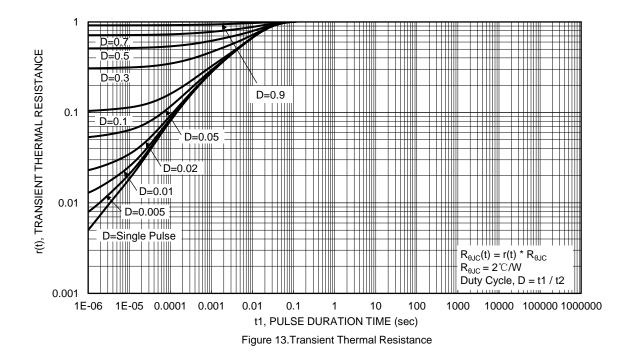




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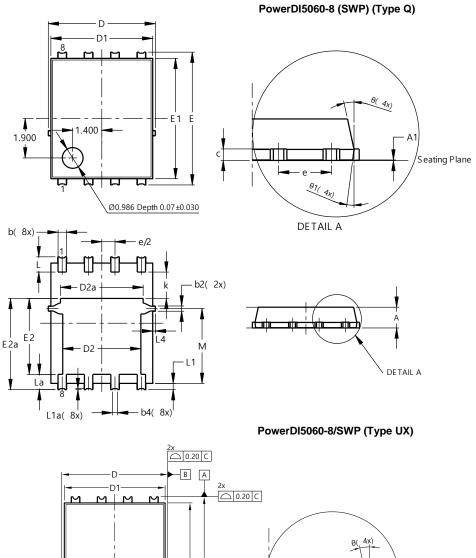




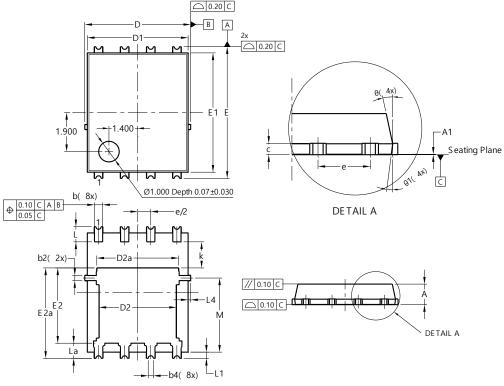


Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



Pov	PowerDI5060-8 (SWP) (Type Q)				
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0	0.05			
b	0.30	0.50	0.41		
b2	0.20	0.35	0.25		
b4	().25REF	-		
С	0.230	0.330	0.277		
D	5	.15 BS0	2		
D1	4.70	5.10	4.90		
D2	3.56	3.96	3.76		
D2a	3.78	4.18	3.98		
E	6	.40 BS0	0		
E1	5.60	6.00	5.80		
E2	3.46	3.86	3.66		
E2a	4.195	4.595	4.395		
е	1	.27BSC)		
k	1.05				
L	0.635	0.835	0.735		
La	0.635	0.835	0.735		
L1	0.200	0.400	0.300		
L1a	0.050REF				
L4	0.025	0.225	0.125		
М	3.205	4.005	3.605		
θ	10°	12°	11°		
θ1	6°	8°	7°		
All	All Dimensions in mm				



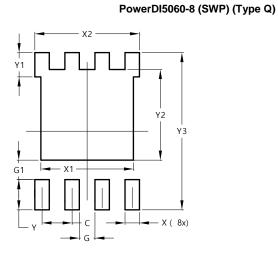
PowerDI5060-8/SWP				
(Type UX)				
Dim	Min	Max	Тур	
Α	0.90	1.10	1.00	
A1	0	0.05		
b	0.30	0.50	0.41	
b2	0.20	0.35	0.25	
b4	().25REF	-	
С	0.230	0.330	0.277	
D		.15 BS(2	
D1	4.70	5.10	4.90	
D2	3.56	3.96	3.76	
D2a	3.78	4.18	3.98	
Е	6	.40 BS0	2	
E1	5.60	6.00	5.80	
E2	3.46	3.86	3.66	
E2a	4.195	4.595	4.395	
е		.27BSC)	
k	1.05			
L	0.635	0.835	0.735	
La	0.635	0.835	0.735	
L1	0.200	0.400	0.300	
L4	0.025	0.225	0.125	
М	3.205	4.005	3.605	
θ	10°	12°	11°	
θ1	6°	8°	7°	
All	All Dimensions in mm			

or the latest version.



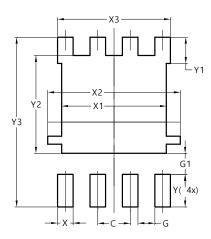
Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value		
Dimensions	(in mm)		
С	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	4.100		
X2	4.420		
Y	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		

PowerDI5060-8/SWP (Type UX)



Dimensions	Value (in mm)		
С	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	4.100		
X2	5.190		
X3	4.420		
Ŷ	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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